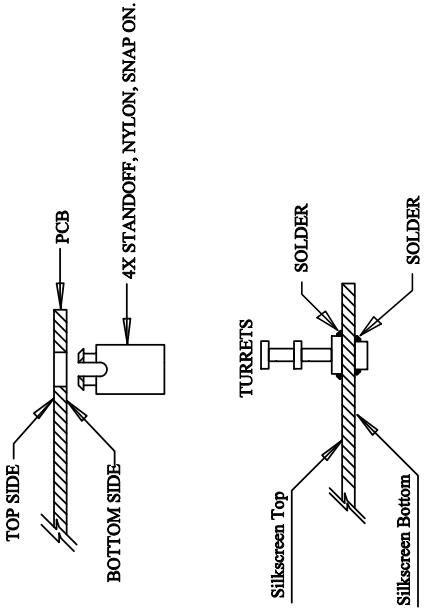




NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILLS OF MATERIAL. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL 4 STANDOFFS AT 4 LOCATIONS AS SHOWN BELOW.



APPROVALS		 ANALOG DEVICES		 POWER BY LINEAR™	
PCB Desgr.		www.analog.com			
APP Engr.		TITLE: TOP ASSEMBLY DRAWING DUAL, LOW NOISE, 2.5A PROGRAMMABLE OUTPUT, LOW DROPOUT LINEAR REGULATOR			
		SIZE	IC NO.LT3072EUFF	DC1938A	REV 3
			N/A		
SCALE = NONE		FILENAME: 1938A-3.PCB		SHT 1 OF 1	